## MBRS410L, NRVBS410L

## Surface Mount Schottky Power Rectifier

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system. Typical applications are AC-DC and DC-DC converters, reverse battery protection, and "ORing" of multiple supply voltages and any other application where performance and size are critical.

## Features

- Ultra Low $\mathrm{V}_{\mathrm{F}}$
- 1st in the Market Place with a $10 \mathrm{~V}_{\mathrm{R}}$ Schottky Rectifier
- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guard-Ring for Stress Protection
- NRVBS Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant


## Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 217 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: $260^{\circ} \mathrm{C}$ Max. for 10 Seconds
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- ESD Ratings: Machine Model = C

Human Body Model = 3B

## MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage <br> Working Peak Reverse Voltage <br> DC Blocking Voltage | $\mathrm{V}_{\mathrm{RRM}}$ <br> $\mathrm{V}_{\mathrm{RWM}}$ | 10 | V |
| Average Rectified Forward Current <br> $\left(@ \mathrm{~T}_{\mathrm{L}}=110^{\circ} \mathrm{C}\right)$ | $\mathrm{I}_{\mathrm{O}}$ | 4.0 | A |
| Non-Repetitive Peak Surge Current <br> (Surge Applied at Rated Load Conditions <br> Halfwave, Single Phase, 60 Hz ) | $\mathrm{I}_{\mathrm{FSM}}$ | 150 | A |
| Operating Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | -65 to +125 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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## SCHOTTKY BARRIER RECTIFIERS

4.0 AMPERES, 10 VOLTS


## MARKING DIAGRAM



B4L1 = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week

- = Pb-Free Package
(Note: Microdot may be in either location)


## ORDERING INFORMATION

| Device | Package | Shipping ${ }^{\dagger}$ |
| :---: | :---: | :---: |
| MBRS410LT3G | SMC <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| NRVBS410LT3G | SMC <br> (Pb-Free) | $2500 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Min Pad (Note 2) | 1 Inch Pad | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Thermal Resistance, Junction-to-Lead | $\mathrm{R}_{\text {өJL }}$ | 12 | 7.0 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Thermal Resistance, Junction-to-Ambient | $\mathrm{R}_{\theta \mathrm{JA}}$ | 109 | 59 |  |

## ELECTRICAL CHARACTERISTICS

| Maximum Instantaneous Forward Voltage (Note 1) | $\mathrm{V}_{\mathrm{F}}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{J}}=100^{\circ} \mathrm{C}$ | V |
| :---: | :---: | :---: | :---: | :---: |
| $\left(\mathrm{I}_{\mathrm{F}}=2.0 \mathrm{~A}\right)$ |  | 0.31 | 0.200 |  |
| $\left(\mathrm{I}_{\mathrm{F}}=4.0 \mathrm{~A}\right)$ |  | 0.33 | 0.225 |  |
| $\left(\mathrm{I}_{\mathrm{F}}=8.0 \mathrm{~A}\right)$ |  | 0.35 | 0.250 |  |
| Maximum Instantaneous Reverse Current (Note 1) <br> (Rated dc Voltage, $\mathrm{V}_{\mathrm{R}}=5.0 \mathrm{~V}$ ) <br> (Rated dc Voltage, $\mathrm{V}_{\mathrm{R}}=10 \mathrm{~V}$ ) | $\mathrm{I}_{\mathrm{R}}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{J}}=100^{\circ} \mathrm{C}$ | mA |
|  |  | 2.0 | 100 |  |
|  |  | 5.0 | 200 |  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width $\leq 300 \mu \mathrm{~s}$, Duty Cycle $\leq 2 \%$.
2. Mounted with Minimum Recommended Pad Size, PC Board FR4.


Figure 1. Typical Forward Voltage


Figure 3. Typical Reverse Current


Figure 2. Maximum Forward Voltage


Figure 4. Typical Capacitance


Figure 5. Current Derating (Junction-to-Lead)


Figure 6. Forward Power Dissipation


Figure 7. Thermal Response, Junction-to-Ambient (min pad)


Figure 8. Thermal Response, Junction-to-Ambient (1 inch pad)

## MBRS410L, NRVBS410L

## PACKAGE DIMENSIONS

## SMC

CASE 403-03
ISSUE E


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.
4. 403-01 THRU -02 OBSOLETE, NEW STANDARD 403-03.

|  | MILLIMETERS |  |  | INCHES |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 1.90 | 2.13 | 2.41 | 0.075 | 0.084 | 0.095 |
| A1 | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 |
| b | 2.92 | 3.00 | 3.07 | 0.115 | 0.118 | 0.121 |
| c | 0.15 | 0.23 | 0.30 | 0.006 | 0.009 | 0.012 |
| D | 5.59 | 5.84 | 6.10 | 0.220 | 0.230 | 0.240 |
| E | 6.60 | 6.86 | 7.11 | 0.260 | 0.270 | 0.280 |
| HE | 7.75 | 7.94 | 8.13 | 0.305 | 0.313 | 0.320 |
| L | 0.76 | 1.02 |  |  | 1.27 | 0.030 |
| L1 | 0.040 |  |  | 0.050 |  |  |

SOLDERING FOOTPRINT*

*For additional information on our Pb -Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.


#### Abstract

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